



1 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Features

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Ultra-low Profile (0.4mm max) Leadless Surface Mount Package Suitable for Compact Portable Electronics
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

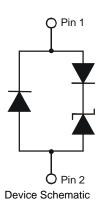
Mechanical Data

- Case: X2-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)





Bottom View



Ordering Information (Note 4)

Part Number	Case	Packaging	
D1213A-01LP4-7B	X2-DFN1006-2	10,000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information

U1

U1 = Product Type Marking Code Line Denotes Pin 1



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	5	Α	8/20µs, Per Figure 2
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

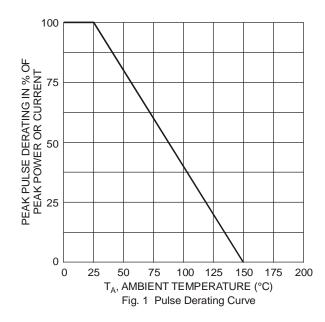
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

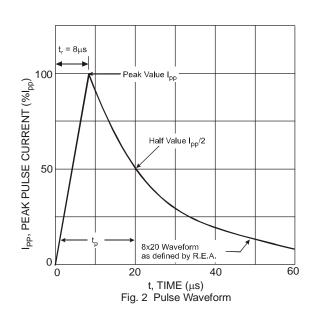
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse working voltage	VRWM	_	_	3.3	V	_
Reverse current (Note 6)	I_R	_	0.1	1.0	μA	$V_R = V_{RWM} = 3.3V$
Reverse breakdown voltage	V_{BR}	6.0	_	_	V	$I_R = 1mA$
Forward voltage	V_{F}	0.6	0.8	0.95	V	$I_F = 8mA$
Reverse clamping voltage, Positive Transients	V _{CL1}	_	10.0	_	V	$I_{PP} = 1A, t_p = 8/20 \mu s$
Reverse clamping voltage, Negative Transients	V _{CL2}	_	-1.7	_	V	$I_{PP} = -1A, t_p = 8/20 \mu s$
Dynamic resistance	R_{DYN}	_	0.9	_	Ω	$I_R = 1A$, $t_p = 8/20 \mu s$
Capacitance	C _T	_	0.85	1.2	pF	V _R = 1.65V, f = 1MHz

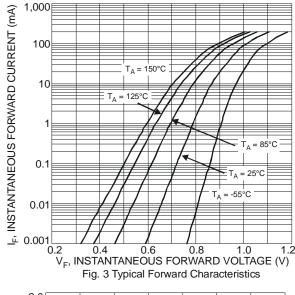
Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.









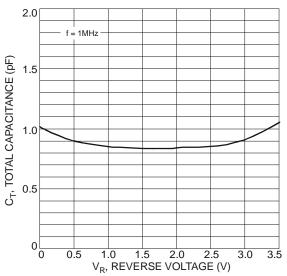
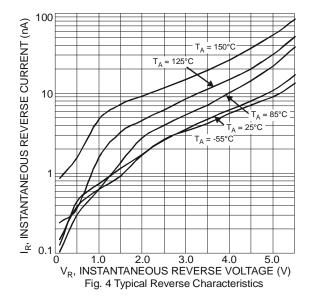
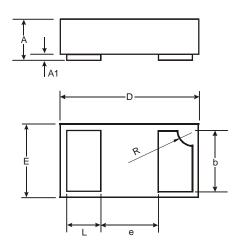


Fig. 5 Typical Total Capacitance vs. Reverse Voltage



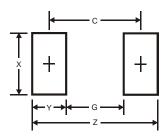
Package Outline Dimensions



X2-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.34	0.4	0.37		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
Е			0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All	All Dimensions in mm				



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
С	0.7

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